

12V LOW V_{CE(sat)} PNP SURFACE MOUNT TRANSISTOR

Features

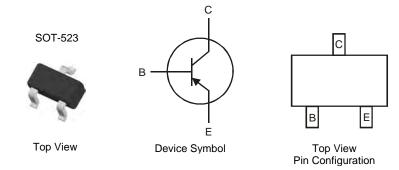
- Low Collector-Emitter Saturation Voltage, V_{CE(sat)}
- Ultra-Small Surface Mount Package
- "Lead Free", RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- ESD rating: 400V-MM, 8KV-HBM

Applications

- DC-DC converter
- Portable equipments
- Power management units

Mechanical Data

- Case: SOT-523
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating) Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Weight: 0.002 grams (approximate)



Ordering Information (Note 3)

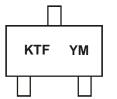
Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
2DA2018-7	KTF	7	8mm	3,000

Notes: 1. No purposefully added lead.

2. Diodes Inc's "Green" Policy can be found on our website at http://www.diodes.com

3. For packaging details, go to our website at http://www.diodes.com

Marking Information



KTF = Product Type Marking Code YM = Date Code Marking Y = Year (ex: W = 2009) M = Month (ex: 9 = September)

Bate Code Ha	.,											
Year	2009		2010	2011		2012	2013		2014	2015		2015
Code	W		Х	Y		Z	A		В	С		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



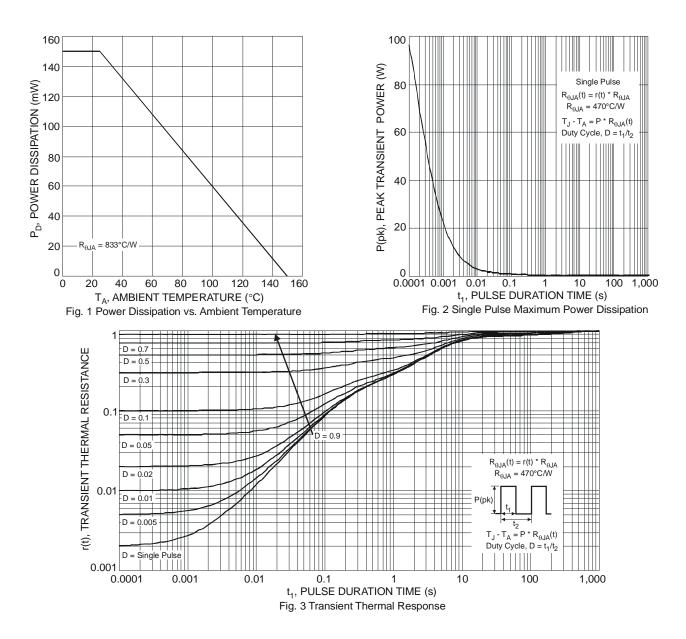
Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-15	V
Collector-Emitter Voltage	V _{CEO}	-12	V
Emitter-Base Voltage	V _{EBO}	-6	V
Collector Current - Continuous	Ic	-500	mA
Peak Pulse Collector Current	I _{CM}	-1	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4) @ $T_A = 25^{\circ}C$	PD	150	mW
Thermal Resistance, Junction to Ambient (Note 4) @ T _A = 25°C	$R_{\theta JA}$	833	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes: 4. Device mounted on FR-4 PCB with minimum recommended pad layout.

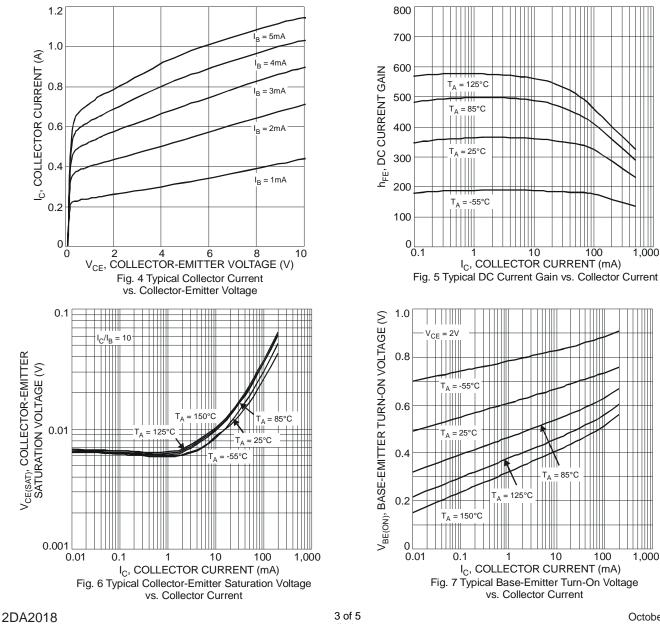




Electrical Characteristics @T_A = 25°C unless otherwise specified

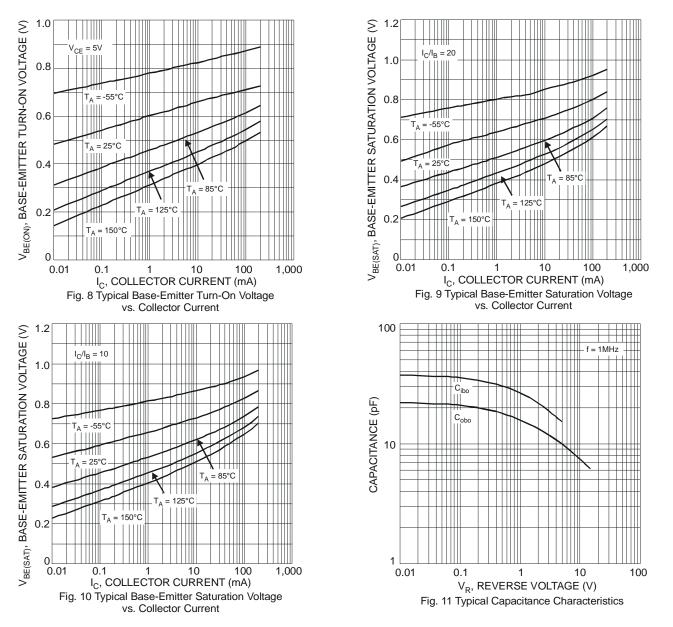
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-15			V	$I_{\rm C} = -10\mu A, I_{\rm E} = 0$
Collector-Emitter Breakdown Voltage (Note 5)	BV _{CEO}	-12		_	V	$I_{\rm C} = -1 {\rm mA}, \ I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	BV _{EBO}	-6			V	$I_{E} = -10 \mu A, I_{C} = 0$
Collector Cutoff Current	I _{CBO}	_	_	-100 -50	nA μA	V _{CB} = -15V, I _E = 0 V _{CB} = -15V, I _E = 0, T _A = 150°C
Emitter Cutoff Current	I _{EBO}	_		-100	nA	$V_{EB} = -6V, I_C = 0$
DC Current Gain (Note 5)	h _{FE}	270		680		$V_{CE} = -2V, I_{C} = -10mA$
Collector-Emitter Saturation Voltage (Note 5)	V _{CE(sat)}	_		-250	mV	I _C = -200mA, I _B = -10mA
Output Capacitance	C _{obo}	_	7.4		pF	V _{CB} = -10V, f = 1.0MHz
Current Gain-Bandwidth Product	f _T	_	260		MHz	V _{CE} = -2V, I _C = -10mA, f = 100MHz
Turn-On Time	t _{on}		40		ns	
Delay Time	t _d		18		ns	
Rise Time	tr	_	22		ns	$V_{CC} = -6V$
Turn-Off Time	t _{off}	_	106		ns	$I_{C} = -200 \text{mA}, I_{B1} = I_{B2} = -10 \text{mA}$
Storage Time	ts	_	87		ns]
Fall Time	t _f	_	19	_	ns	

Notes: 5. Measured under pulsed conditions. Pulse width = 300μ s. Duty cycle $\leq 2\%$.

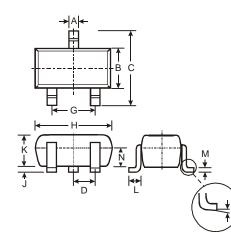


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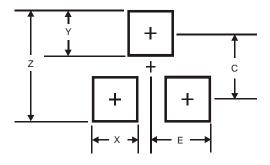
Package Outline Dimensions



	SOT-523						
Dim	Min	Max	Тур				
Α	0.15	0.30	0.22				
В	0.75	0.85	0.80				
С	1.45	1.75	1.60				
D		_	0.50				
G	0.90	1.10	1.00				
Н	1.50	1.70	1.60				
J	0.00	0.10	0.05				
K	0.60	0.80	0.75				
L	0.10	0.30	0.22				
М	0.10	0.20	0.12				
Ν	0.45	0.65	0.50				
α	0°	8°	_				
All	All Dimensions in mm						



Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.8
Х	0.4
Y	0.51
С	1.3
E	0.7

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